

Substitute Form PTO-1449 (Modified)	U.S. Department of Commerce Patent and Trademark Office	Attorney's Docket No. 00614-136002	Application No. 10/802,379
<b>Information Disclosure Statement by Applicant</b> (Use several sheets if necessary) (37 CFR §1.98(b))		Applicant Patrizio Vinciarelli	
		Filing Date March 17, 2004	Group Art Unit 2838

## U.S. Patent Documents

Examiner Initial	Desig. ID	Document Number	Publication Date	Patentee	Class	Subclass	Filing Date If Appropriate
↑	AA	5,073,848	12/17/91	Steigerwald et al.	363	65	—
↓	AB	5,500,791	03/19/96	Kheraluwala et al.	363	17	—
↓	AC	5,576,940	11/19/96	Steigerwald et al.	363	17	—
↓	AD	5,726,849	03/10/98	Nakamura	361	93	—
↓	AE	5,861,738	01/19/99	Becker-Irvin et al.	323	282	—
↓	AF	6,069,811	05/30/00	Moriguchi et al.	363	142	—
↓	AG	6,310,792	10/30/01	Drobnik	363	147	—
↓	AH	6,583,999	06/24/03	Spindler et al.	363	98	—

## Foreign Patent Documents or Published Foreign Patent Applications

Examiner Initial	Desig. ID	Document Number	Publication Date	Country or Patent Office	Class	Subclass	Translation	
							Yes	No
↑	AI	EP 0550167	07/07/93	EP	H02M	3/335	—	—
↓	AJ	EP 0696831	02/14/96	EP	H02J	9/06	—	—
↓	AK	DE 19546936	06/19/97	Germany	H02M	3/28		X
↓	AL	WO 98/11658	03/19/98	WIPO	H02M	3/337		X
↓	AM	EP 0848485	06/17/98	EP	H02M	3/335	—	—
↓	AN	DE 19837639	03/02/00	Germany	H02H	7/10		X

## Other Documents (include Author, Title, Date, and Place of Publication)

Examiner Initial	Desig. ID	Document
↑	AO	Brakus, B., "DC/DC Modules for Low Voltage Applications. The New Generation of Board Mounted Modules in Thick-Copper Multi-Layer Technology", IEEE, 1998, pp. 392-397.
↓	AP	Casey et al., "A High-Frequency, Low Volume, Point-of-Load Power Supply for Distributed Power Systems," IEEE Transactions on Power Electronics, Vol. 3, No. 1, January 1988.
↓	AQ	Hua et al., "Development of a DC Distributed Power System", IEEE, 1994, pp. 763-769.

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Examiner Signature <i>Stewart</i>	Date Considered 3/10/05
EXAMINER: Initials citation considered. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.	